

## N-Channel Power MOSFET

600V, 7A, 1.2Ω

### FEATURES

- 100% UIS and  $R_g$  tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### KEY PERFORMANCE PARAMETERS

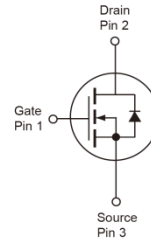
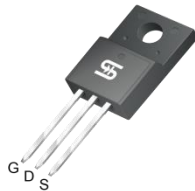
| PARAMETER          | VALUE | UNIT |
|--------------------|-------|------|
| $V_{DS}$           | 600   | V    |
| $R_{DS(on)}$ (max) | 1.2   | Ω    |
| $Q_g$              | 24    | nC   |

### APPLICATIONS

- AC/DC LED Lighting
- Power Supply



ITO-220S



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| PARAMETER                                          | SYMBOL         | Limit                     | UNIT |
|----------------------------------------------------|----------------|---------------------------|------|
| Drain-Source Voltage                               | $V_{DS}$       | 600                       | V    |
| Gate-Source Voltage                                | $V_{GS}$       | ±30                       | V    |
| Continuous Drain Current (Note 1)                  | $I_D$          | $T_C = 25^\circ\text{C}$  | A    |
|                                                    |                | $T_C = 100^\circ\text{C}$ |      |
| Pulsed Drain Current (Note 2)                      | $I_{DM}$       | 21                        | A    |
| Total Power Dissipation @ $T_C = 25^\circ\text{C}$ | $P_{DTOT}$     | 44.6                      | W    |
| Single Pulse Avalanche Energy (Note 3)             | $E_{AS}$       | 270                       | mJ   |
| Single Pulse Avalanche Current (Note 3)            | $I_{AS}$       | 5.2                       | A    |
| Operating Junction and Storage Temperature Range   | $T_J, T_{STG}$ | - 55 to +150              | °C   |

### THERMAL PERFORMANCE

| PARAMETER                              | SYMBOL          | Limit | UNIT |
|----------------------------------------|-----------------|-------|------|
| Junction to Case Thermal Resistance    | $R_{\theta JC}$ | 2.8   | °C/W |
| Junction to Ambient Thermal Resistance | $R_{\theta JA}$ | 62    | °C/W |

**Thermal Performance Note:**  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\theta JA}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.  $R_{\theta JA}$  shown below for single device operation on FR-4 PCB in still air.

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| PARAMETER                                    | CONDITIONS                                                  | SYMBOL       | MIN | TYP  | MAX       | UNIT     |
|----------------------------------------------|-------------------------------------------------------------|--------------|-----|------|-----------|----------|
| Static                                       |                                                             |              |     |      |           |          |
| Drain-Source Breakdown Voltage               | $V_{GS} = 0V, I_D = 250\mu A$                               | $BV_{DSS}$   | 600 | --   | --        | V        |
| Gate Threshold Voltage                       | $V_{DS} = V_{GS}, I_D = 250\mu A$                           | $V_{GS(TH)}$ | 2.5 | 3.5  | 4.5       | V        |
| Gate Body Leakage                            | $V_{GS} = \pm 30V, V_{DS} = 0V$                             | $I_{GSS}$    | --  | --   | $\pm 100$ | nA       |
| Zero Gate Voltage Drain Current              | $V_{DS} = 600V, V_{GS} = 0V$                                | $I_{DSS}$    | --  | --   | 1         | $\mu A$  |
| Drain-Source On-State Resistance<br>(Note 4) | $V_{GS} = 10V, I_D = 2A$                                    | $R_{DS(on)}$ | --  | 1.07 | 1.2       | $\Omega$ |
| Forward Transconductance (Note 4)            | $V_{DS} = 10V, I_D = 4A$                                    | $g_{fs}$     | --  | 5    | --        | S        |
| Dynamic (Note 5)                             |                                                             |              |     |      |           |          |
| Total Gate Charge                            | $V_{DS} = 480V, I_D = 4A,$<br>$V_{GS} = 10V$                | $Q_g$        | --  | 24   | --        | nC       |
| Gate-Source Charge                           |                                                             | $Q_{gs}$     | --  | 7.2  | --        |          |
| Gate-Drain Charge                            |                                                             | $Q_{gd}$     | --  | 8.2  | --        |          |
| Input Capacitance                            | $V_{DS} = 50V, V_{GS} = 0V,$<br>$f = 1.0MHz$                | $C_{iss}$    | --  | 1169 | --        | pF       |
| Output Capacitance                           |                                                             | $C_{oss}$    | --  | 62   | --        |          |
| Reverse Transfer Capacitance                 |                                                             | $C_{rss}$    | --  | 5    | --        |          |
| Gate Resistance                              | $f = 1.0MHz, \text{open drain}$                             | $R_g$        | 1   | 3.4  | 6.8       | $\Omega$ |
| Switching (Note 6)                           |                                                             |              |     |      |           |          |
| Turn-On Delay Time                           | $V_{DD} = 300V, R_G = 5\Omega,$<br>$I_D = 4A, V_{GS} = 10V$ | $t_{d(on)}$  | --  | 10.4 | --        | ns       |
| Turn-On Rise Time                            |                                                             | $t_r$        | --  | 17   | --        |          |
| Turn-Off Delay Time                          |                                                             | $t_{d(off)}$ | --  | 20   | --        |          |
| Turn-Off Fall Time                           |                                                             | $t_f$        | --  | 27.6 | --        |          |
| Source-Drain Diode                           |                                                             |              |     |      |           |          |
| Forward Voltage (Note 4)                     | $I_S = 4A, V_{GS} = 0V$                                     | $V_{SD}$     | --  | --   | 1.3       | V        |
| Reverse Recovery Time                        | $I_S = 4A$<br>$dI_F/dt = 100A/\mu s$                        | $t_{rr}$     | --  | 246  | --        | ns       |
| Reverse Recovery Charge                      |                                                             | $Q_{rr}$     | --  | 2    | --        | $\mu C$  |

**Notes:**

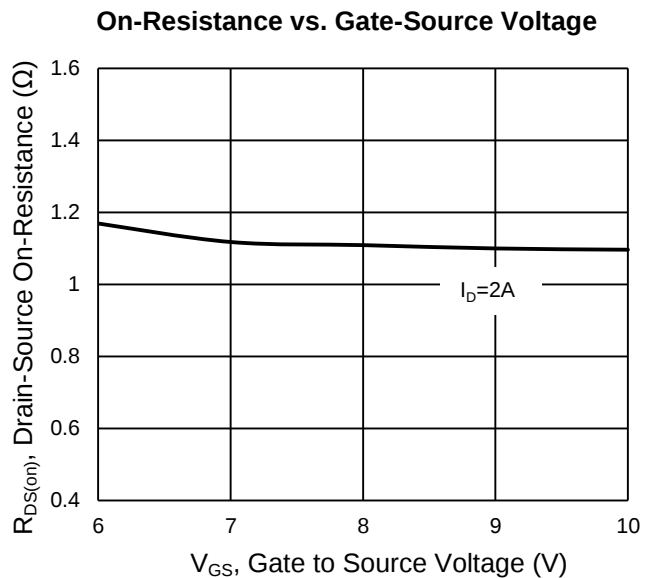
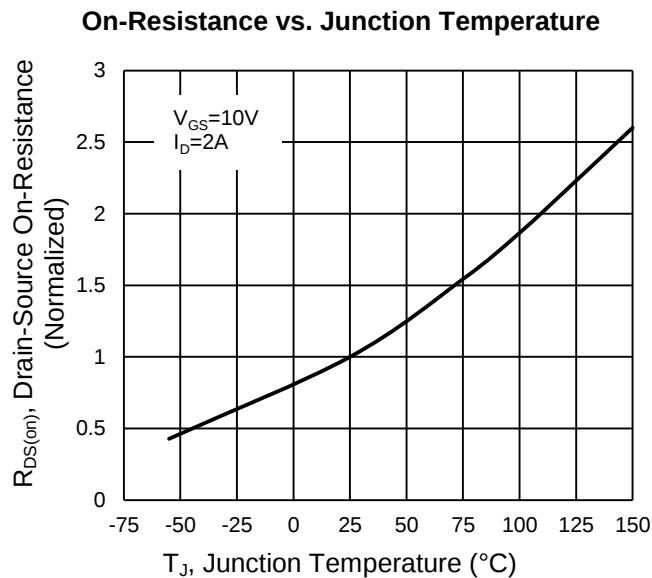
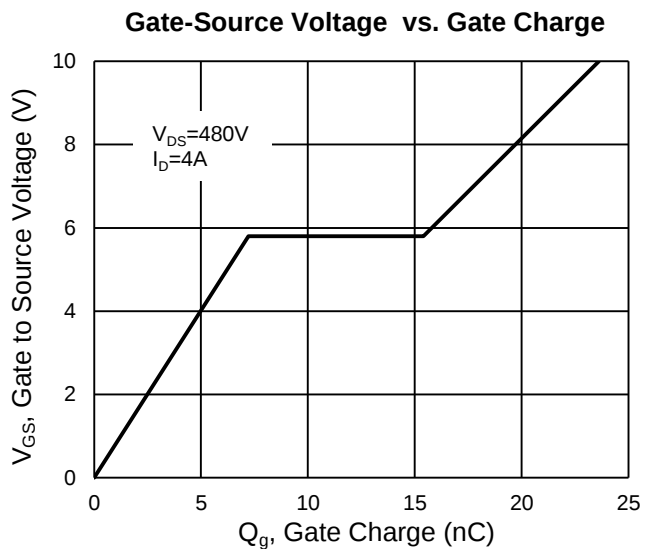
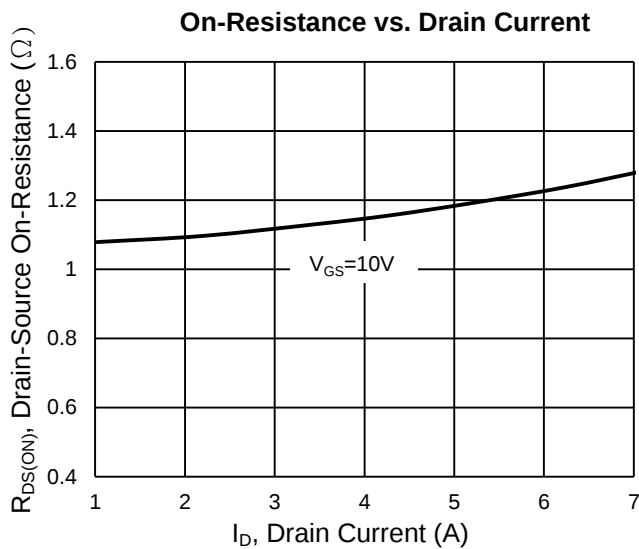
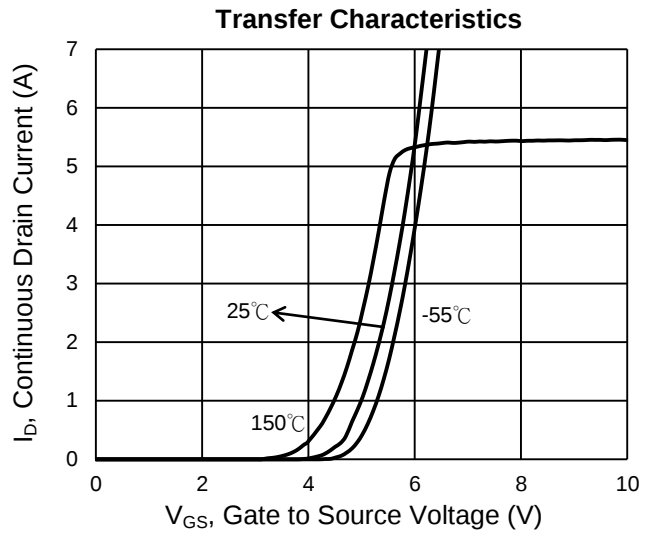
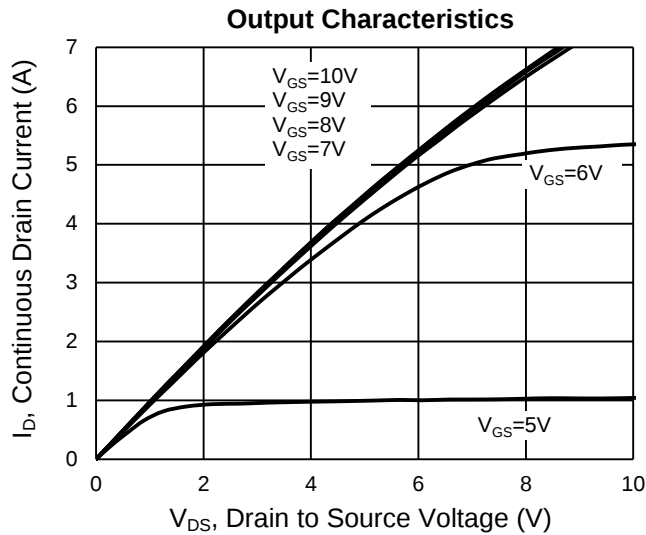
1. Current limited by package
2. Pulse width limited by the maximum junction temperature
3.  $L = 20mH, I_{AS} = 5.2A, V_{DD} = 50V, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse test:  $PW \leq 300\mu s$ , duty cycle  $\leq 2\%$
5. For DESIGN AID ONLY, not subject to production testing.
6. Switching time is essentially independent of operating temperature.

**ORDERING INFORMATION**

| PART NO.       | PACKAGE  | PACKING      |
|----------------|----------|--------------|
| TSM7NC60CF C0G | ITO-220S | 50pcs / Tube |

## CHARACTERISTICS CURVES

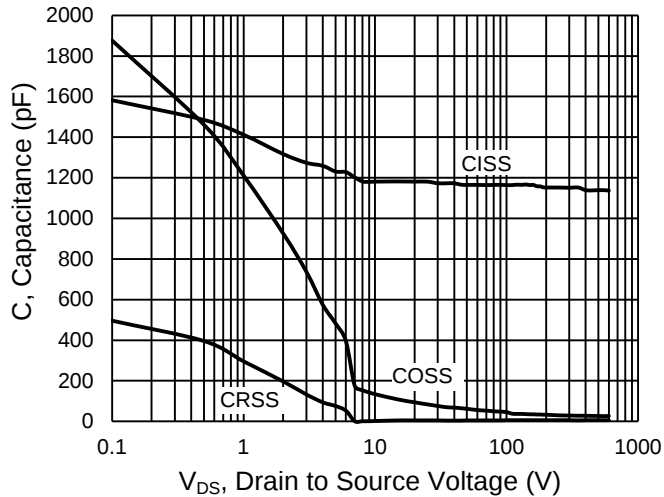
( $T_A = 25^\circ\text{C}$  unless otherwise noted)



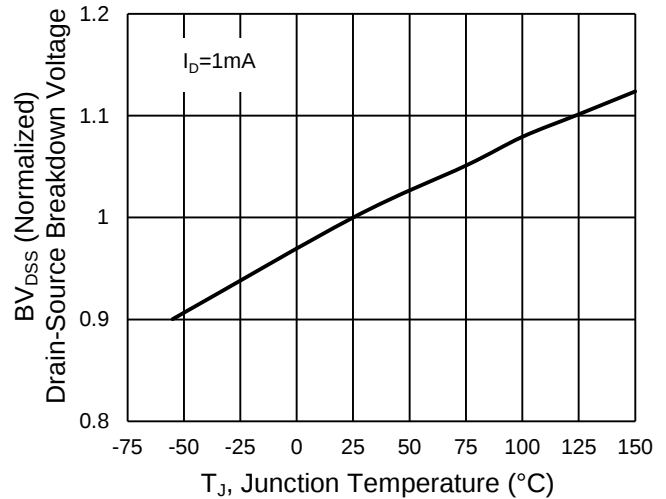
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

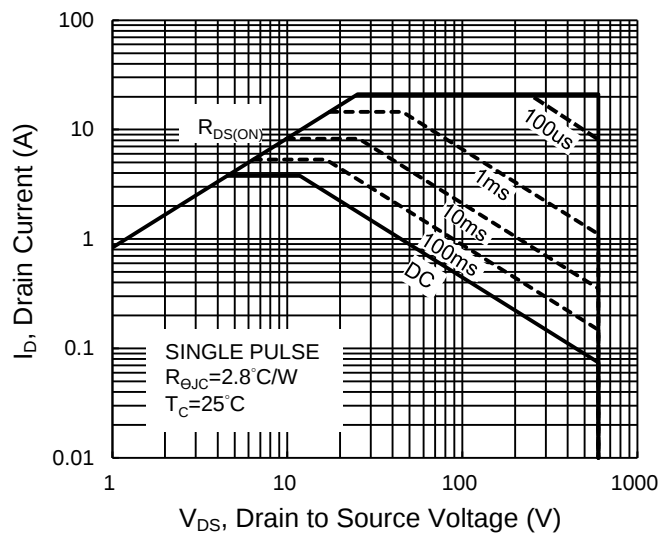
**Capacitance vs. Drain-Source Voltage**



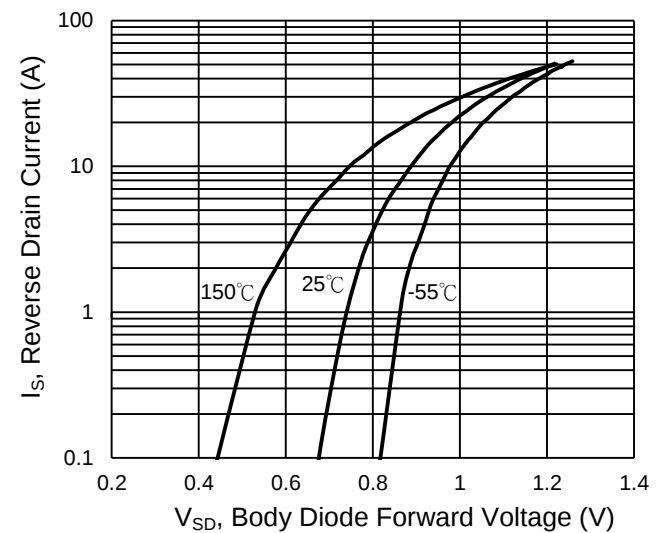
**$BV_{DSS}$  vs. Junction Temperature**



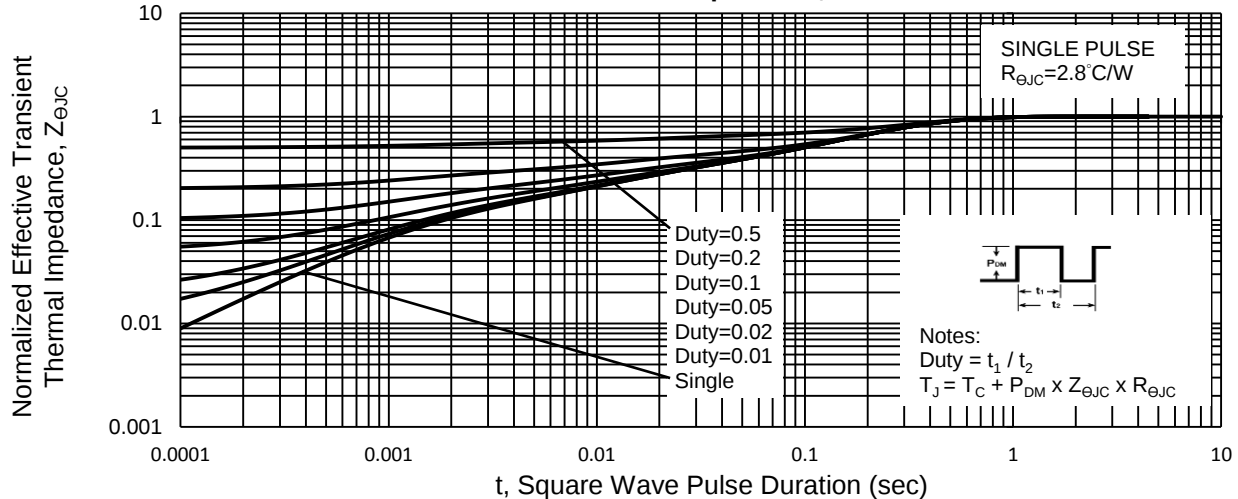
**Maximum Safe Operating Area, Junction-to-Case**



**Source-Drain Diode Forward Current vs. Voltage**

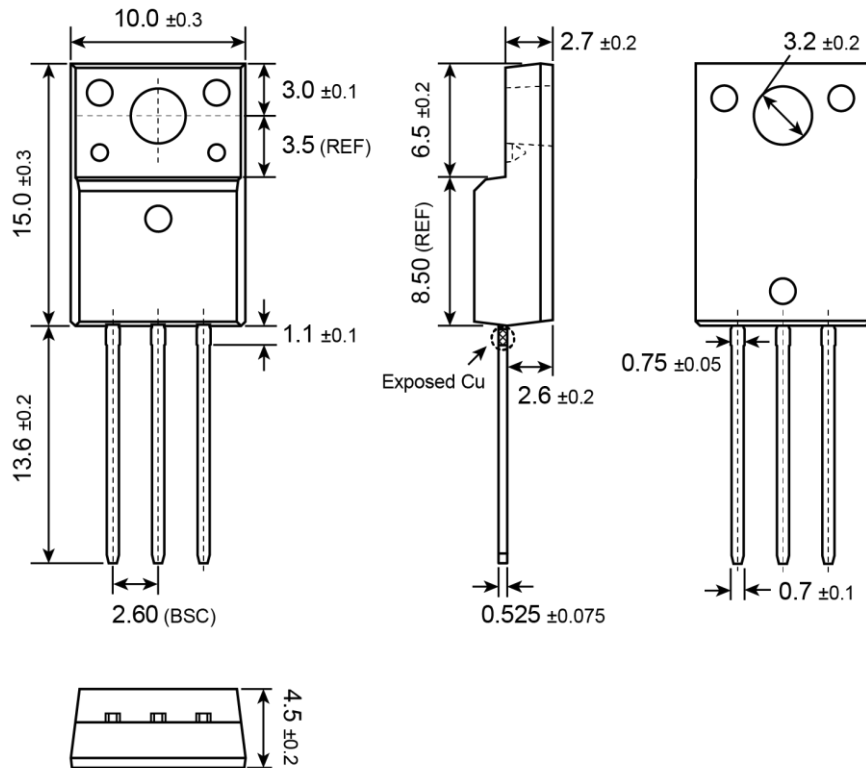


**Normalized Thermal Transient Impedance, Junction-to-Case**

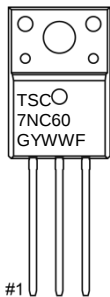


### PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

## ITO-220S



## MARKING DIAGRAM



**G** = Halogen Free  
**Y** = Year Code  
**WW** = Week Code (01~52)  
**F** = Factory Code

## Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9